## SINGLE-PHASE GLASS PASSIVATED SILICON <br> SURFACE MOUNT BRIDGE RECTIFIER

Reverse Voltage - 50 to 1000 V
Forward Current - 1 A

## Features

- High surge overload rating of 50 A peak
- Ideal for printed circuit board
- Low forward voltage drop
- Glass passivated chip junction


## Mechanical Data

- Case: Molded plastic, DB-S
- Epoxy: UL 94V-0 rate flame retardant
- Terminal: Leads solderable per MIL-STD-202, method 208 guaranteed
- Mounting position: Any



## DB-S


$\frac{126(3.2)}{102(2.6)}$

## Dimensions in inches and (millimeters)

## Maximum Ratings and Electrical Characteristics

Ratings at $25^{\circ} \mathrm{C}$ ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz , resistive or inductive load.For capacitive load, derate current by 20\%.

| Parameter | Symbols | DB101S | DB102S | DB103S | DB104S | DB105S | DB106S | DB107S | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Recurrent Peak Reverse Voltage | $\mathrm{V}_{\text {RRM }}$ | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Voltage | $\mathrm{V}_{\text {RMS }}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | $V_{\text {DC }}$ | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current at $\mathrm{T}_{\mathrm{A}}=40^{\circ} \mathrm{C}^{2)}$ | $\mathrm{I}_{\text {(AV) }}$ | 1 |  |  |  |  |  |  | A |
| Peak Forward Surge Current 8.3 ms Single Half-sine -wave Superimposed on Rated Load (JEDEC Method) | $\mathrm{I}_{\text {FSM }}$ | 50 |  |  |  |  |  |  | A |
| Maximum Forward Voltage at 1 A DC | $V_{F}$ | 1.1 |  |  |  |  |  |  | V |
| Maximum Reverse Current $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> at Rated DC Blocking Voltage $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ | $I_{R}$ | $\begin{gathered} 5 \\ 500 \end{gathered}$ |  |  |  |  |  |  | $\mu \mathrm{A}$ |
| Typical Junction Capacitance ${ }^{1)}$ | $\mathrm{C}_{3}$ | 25 |  |  |  |  |  |  | pF |
| Typical Thermal Resistance ${ }^{2)}$ | $\mathrm{R}_{\theta \mathrm{JA}}$ | 40 |  |  |  |  |  |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Typical Thermal Resistance ${ }^{2)}$ | $\mathrm{R}_{\text {өJL }}$ | 15 |  |  |  |  |  |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{j}}, \mathrm{T}_{\text {stg }}$ | -55 to + 150 |  |  |  |  |  |  | ${ }^{\circ} \mathrm{C}$ |

${ }^{1)}$ Measured at 1 MHz and applied reverse voltage of 4 VDC .
${ }^{2)}$ Units mounted P.C.B. with $0.5 \times 0.5^{\prime \prime}(13 \times 13 \mathrm{~mm})$ copper pads.

Fig. 1 - Derating Curve Output Rectified Current


Fig. 3 - Typical Forward Characteristics
Per Leg


Fig. 5 - Typical Junction Capacitance Per Leg


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Leg


Fig. 4 - Typical Reverse Leakage Characteristics Per Leg


Fig. 6 - Typical Transient Thermal Impedance


